

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Paul Gwin</td> <td>08/22/2013</td> </tr> <tr> <td>Harish Jagadish</td> <td>08/03/2013</td> </tr> <tr> <td>Narasimha Shastri</td> <td>07/26/2013</td> </tr> <tr> <td>Madhukar Patil</td> <td>08/23/2013</td> </tr> </tbody> </table>		Name	Execution Date	Paul Gwin	08/22/2013	Harish Jagadish	08/03/2013	Narasimha Shastri	07/26/2013	Madhukar Patil	08/23/2013
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Paul Gwin	08/22/2013										
Harish Jagadish	08/03/2013										
Narasimha Shastri	07/26/2013										
Madhukar Patil	08/23/2013										
RECEIVING PARTY DATA											
Name:	Intel Corporation										
Street Address:	2200 Mission College Blvd.										
City:	Santa Clara										
State/Country:	CALIFORNIA										
Postal Code:	95054										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13937501</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13937501						
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Application Number:	13937501										
CORRESPONDENCE DATA											
Fax Number:	6123328352										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Email:	inteldocs@cpaglobal.com										
Correspondent Name:	International IP Law Group, P.L.L.C.										
Address Line 1:	c/o CPA Global										
Address Line 2:	PO Box 52050										
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ATTORNEY DOCKET NUMBER:	P56204										
NAME OF SUBMITTER:	Melissa Aubin										
Signature:	/Melissa Aubin/										

Date:

09/05/2013

**Total Attachments: 8**

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**ASSIGNMENT**

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**PAUL GWIN; HARISH JAGADISH; NARASIMHA SHASTRI; MADHUKAR PATIL**

hereby sell, assign, and transfer to:

**Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

**COOLING ELECTRONIC DEVICES**

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on July 9, 2013 as  
US Application Number 13/937,501 and  
COUNTRY or International Office

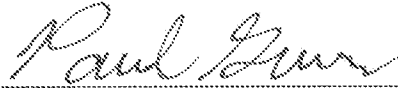
which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications: as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

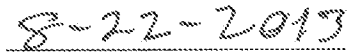
and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and

maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Paul Gwin



Date signed

Harish Jagadish

Date signed

Narasimha Shastri

Date signed

Madhukar Patil

Date signed

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_____ Paul Gwin	_____ Date signed
 _____ Harish Jagadish	<u>3 AUG 2013</u> _____ Date signed
_____ Narasimha Shastri	_____ Date signed
_____ Madhukar Patil	_____ Date signed

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\_\_\_\_\_  
Paul Gwin

\_\_\_\_\_  
Date signed

\_\_\_\_\_  
Harish Jagadish

\_\_\_\_\_  
Date signed

*Narasimha Shastri*  
\_\_\_\_\_

Narasimha Shastri

*26-Jul-2013*  
\_\_\_\_\_

Date signed

\_\_\_\_\_  
Madhukar Patil

\_\_\_\_\_  
Date signed



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Paul Gwin

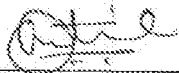
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Harish Jagadish

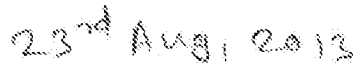
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